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10. (Original) The semiconductor device according to claim 1, further comprising an interlayer insulating film formed between said gate electrodes adjacent to each other, and a film that has a low specific inductive capacity at least lower than the specific inductive capacity of a silicon oxide film, said film being formed on said interlayer insulating film and said gate electrode.

DI Cont.

11. (Original) The semiconductor device according to claim 1, further comprising a contact electrode connected to said gate electrode on said gate electrode, and connected to one of said impurity diffusion layers.

Claims 12-20 (Withdrawn)



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APPL PARTS	NPL	CTNF
	Non-Patent Literature	Count Non-Final
IMIS	OATH	CTRS
Internal Misc. Paper	Oath or Declaration	Count Restriction
LET.	PET	EXIN
Misc. Incoming Letter	Petition	Examiner Interview
371P	RETMAIL Mail Returned by USPS	M903
PCT Papers in a 371Application	Mail Returned by USPS	DO/EO Acceptance
A	SEQLIST	M905
Amendment Including Elections	Sequence Listing	DO/EO Missing Requirement
ABST	SPEC	NFDR
Abstract	Specification SPEC	Formal Drawing Required
ADS	SPEC NO	NOA
Application Data Sheet	Specification Not in English	Notice of Allowance
AF/D	TRNA	PETDEC
Affidavit or Exhibit Received	Transmittal New Application	Petition Decision
APPENDIX		-
APPENDIXAPPENDIX		
ARTIFACT	OUT COIN'S	Magina
Artifact	OUTGOING	INCOMING
BIB	CTMS	AP.B
Bib Data Sheet	Misc. Office Action	Appeal Brief
CLM	1449 Signed 1449	C.AD Change of Address
	•	
COMPUTER Computer Program Listing	892	Notice of Appeal
		* *
CRFL	ABN	PA Change in Power of Attorney
All CRF Papers for Backfile		Change in Power of Attorney
DIST	APDEC	REM _ <u>\$</u>
Terminal Disclaimer Filed	Board of Appeals Decision	Applicant Remarks in Amendment
DRW	APEA	XT/
Drawings	Examiner Answer	Extension of Time filed separate
FOR	CTAV	
Foreign Reference	Count Advisory Action	
FRPR	CTEQ	
Foreign Priority Papers	Count Ex parte Quayle	
IDS	CTFR	File Wrapper
IDS Including 1449	Count Final Rejection	The Wapper
•		
	ECBOX	FWCLM
Internal	Evidence Copy Box Identification	File Wrapper Claim
SRNT	WCLM	IIFW
Examiner Search Notes	Claim Worksheet	File Wrapper Issue Information
	Cialli Horizonicol I	

WFEE

Fee Worksheet

SRFW File Wrapper Search Info

CLMPTO Propaged Complete Claim Set

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REMARKS

At the time of the Office Action dated January 15, 2003, claims 1-20 were pending in this application. Of those claims, claims 1-11 have been rejected and claims 12-20 have been withdrawn from consideration pursuant to the provisions of 37 C.F.R. § 1.142(b). Claim 1 has been amended to recite that a first insulating film is in contact with a semiconductor substrate, consistent with the paragraph spanning pages 10 and 11 of Applicants' originally-filed disclosure. Claim 2 has been cancelled. Claims 5-7 have been amended to be placed in independent form. Claim 6 has also been amended to recite that the thickness of a second insulating film on the top surface of a gate electrode is greater than the thickness of the second insulating film on the surface of a semiconductor substrate, consistent with page 16 of the disclosure. Applicants submit that the present Amendment does not generate any new matter issue.

Claim 2 is objected under 37 C.F.R. § 1.75(c)

Claim 2 has been cancelled. As such, the Examiner's objection to claim 2 is moot.

Claims 1-11 are rejected under the second paragraph of 35 U.S.C. § 112

On the second page of the statement of the rejection, the Examiner asserted that the use of the word "substantially" in claims 1 and 7 renders the claimed invention indefinite. This basis for the rejection is respectfully but vigorously traversed.

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Applicants incorporate herein the arguments previously presented in the Amendment filed October 22, 2002, regarding this issue. On page five of the Office Action, the Examiner responded by asserting:

Regarding "substantially", applicant [sic] argues that such language is employed so that the thickness recited in not uniform to the nth degree. Nonetheless, such meaning is not characterized from the original disclosure. It remains that the degree of variation cannot be determined from the specification.

The issue of whether the term "substantially" is indefinite was recently revisited by the Federal Circuit in Verve, LLC v. Crane Cams, Inc., Case No. 01-1417 (Fed. Cir. November 14, 2002). The case was brought on appeal before the Federal Circuit after the district court determined the expression "substantially constant wall thickness" was indefinite for lack in the specification or prosecution history of "a sufficiently clear definition of 'substantially'." The Federal Circuit, however, disapproved of the district court's analysis that the term "substantially" was indefinite because it was not further defined in the specification. As stated by the Federal Circuit:

Patent documents are written for persons familiar with the relevant field; the patentee is not required to include in the specification information readily understood by practitioners, lest every patent be required to be written as a comprehensive tutorial and treatise for the generalist, instead of a concise statement for persons in the field.

The Federal Circuit then relied upon previous case law, which described "substantially" as "a descriptive term commonly used in patent claims 'to avoid a strict numerical boundary to the specified parameter." The Federal Circuit concluded with regard to the indefiniteness issue by holding:

It is well establish that when the term "substantially" serves reasonably to describe the subject matter so that its scope would be understood by persons in the field of the invention, and to distinguish the claimed subject matter from the prior art, it is not indefinite. (emphasis added)